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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/076,630	02/19/2002	Chia-Chi Chung	8409.0004-00	2599	
75	590 08/26/2003				
Finnegan, Henderson, Farabow,			EXAMINER		
Garrett & Dunner, L.L.P. 1300 I Street, N.W. Washington, DC 20005-3315			LEE, CALVIN		
			ART UNIT	PAPER NUMBER	
		•	2825	2825 DATE MAILED: 08/26/2003	
		•	DATE MAILED: 08/26/2003		

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)				
	10/076,630	CHUNG ET AL.				
Office Action Summary	Examiner	Art Unit				
	Lee Calvin	2825				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b). Status	16(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) days ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONEI	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).				
1) Responsive to communication(s) filed on 29 J	<u>uly 2003</u> .					
2a)⊠ This action is FINAL . 2b)□ Thi	s action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. Disposition of Claims						
4) Claim(s) 1-11 is/are pending in the application						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1-11</u> is/are rejected.						
7) Claim(s) is/are objected to.						
8) Claim(s) are subject to restriction and/or	r election requirement.					
Application Papers						
9) The specification is objected to by the Examine						
10) ☐ The drawing(s) filed on is/are: a) ☐ accept						
Applicant may not request that any objection to the						
11)☐ The proposed drawing correction filed on		oved by the Examiner.				
If approved, corrected drawings are required in reply to this Office action.						
12) The oath or declaration is objected to by the Ex-	aminer.					
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign	priority under 35 U.S.C. § 119(a)-(d) or (f).				
a) ☐ All b) ☐ Some * c) ☐ None of:						
1. Certified copies of the priority documents	s have been received.					
2. Certified copies of the priority documents	s have been received in Applicati	on No				
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).						
a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.						
Attachment(s)						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Informal	(PTO-413) Paper No(s) Patent Application (PTO-152)				

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FINAL ACTION

Response to Amendment

1. The amendment of claim 1, filed on July 29, 2003, is acknowledged.

Claim Rejections - 35 U.S.C. § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 1-4, 6-9, and 11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Wu (US 6,511,916) in view of Tu et al. (US 6,147,005).

Wu discloses a method for improving alignment in dual damascene, comprising the steps:

- defining and patterning a first photoresist 440 formed over an insulating layer 410-430
- etching the insulating material to form a groove 460 [Fig. 4B and col. 4, ln. 31]
- removing the first photoresist [Fig. 4C and col. 4, ln. 31]
- defining an patterning a second photoresist 470 formed over the insulating layer [col. 4, ln. 50]
- depositing a polymer layer over the tops and sidewalls of the second photoresist [col. 4, ln. 61]
- etching the insulating layer to form an opening 460 aligned with the groove 490 [Figs. 4D-4E]
- filling the opening with metal to conventionally form/finish a via [col. 1, ln. 34]

Wu inherently teaches depositing a layer of carbon-fluoride material because a carbon-fluoride material is found in a polymer that is layer 480 in Wu reference. Nevertheless, such polymer layer of carbon-fluoride material is notoriously well-known in the semiconductor processing art as evidenced by Tu et al teaching a polymer comprised of both carbon and fluoride materials "the polymer layer 24...be formed by...adjusting the etching recipe...by increasing the fluorine atoms...much more polymer layer is formed...by increasing the carbon atoms". Tu et al also discloses to deposit a polymer layer 24 over the tops and sidewalls of a photoresist 22 [Fig. 4a], wherein the polymer layer is formed through a PECVD process [col.4, ln.55] at about 20°C (meets claims 2, 4, 7, and 9).

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b) Moreover, *Tu et al* discloses to obtain the ratio of carbon to fluorine by using/adjusting according to preferred etching rate and efficient [col. 4, lns.36-56], but not explicitly as the ratio of carbon to fluorine in the carbon-fluoride material being at least 0.25 (meets claims 3 and 8).

It would have been obvious to one having ordinary skill to have modified the carbon-fluorine layer formation of *Tu et al* by utilizing the claimed ratio because one would adjust atoms amount of carbon and/or fluorine to result the claimed carbon-fluorine ratio of 0.25.

a) Wu suggests dry etching but not anisotropically etching the insulating layer. Tu et al. discloses anisotropically etching an insulating layer 4 to create an opening 27 [Fig. 6B and col 5]

It would have been obvious to one having ordinary skill in the art to have modified the etching process of Wu by utilizing the claimed etching because such anisotropically etching technique is notoriously well known in the art to remove a semiconductor layer.

4. Claims 5 and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Wu and Tu et al, as applied to claims 1 and 6, in view of Lin et al. (US 6,376,366).

The combination of Wu and Tu et al. does not teach or suggest a defined and patterned photoresist is misaligned with a groove. Lin et al. discloses a defined and patterned photoresist 260 is misaligned with a groove 255 formed inside an insulating layer 240 [Fig. 2d and col. 5].

It would have been obvious to one having ordinary skill to have modified the method of Wu and Tu et al. by utilizing the misaligned process in dual damascene because it simplifies dual damascene process in sub-micron technologies.

Response to Arguments

5. Applicants' argument that "Wu does not describe a method for improving misalignment of photoresist" is persuasive. However, the removal of photoresist and polymer residual, taught by Wu, eventually will benefit the improvement of photoresist misalignment [col. 1, "the best method of the interconnect process ... the trench profile deformation"].

Admittedly, Wu is silent about a carbon-fluoride material. In fact, a polymer comprises both carbon and fluoride materials. It is understood that a polymer is a carbon-fluoride material.

Applicants also argued that Tu et al fails to cure the stated deficiencies of Wu. Examiner notes that Wu teaches the invention features except for the teachings of anisotropical etching. So Wu in view of Tu et al obviates the deficiency of etching in Wu.

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Applicants do not claim the insulating layer as a single layer. Therefore, the examiner does consider Wu's first and second dielectric layers as corresponding to the claimed insulating layer.

Please note also in the rejection above, that the specific portions of Wu in view of Tu et al, relied upon by the Examiner to reject the pending claims 1-11, have been pointed out.

In conclusion, Applicant's arguments are moot in light of a final rejection.

6. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire three months from the mailing date of this action. In the event a first reply is filed within two months of the mailing date of this final action and the advisory action is not mailed until after the end of the three-month shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than six months from the date of this final action.

Contact Information

7. Any inquiry concerning this communication from the Examiner should be directed to Calvin Lee at 703-306-5854, Monday to Thursday, from 7 to 5 (ET). If attempts to reach the examiner by telephone are unsuccessful, Art Unit 2825's Supervisory Patent Examiner Matthew Smith whose telephone number is 703-308-1323

Any inquiry relating to the status of this application should be directed to the Group receptionist whose telephone number is (703) 308-0596. The fax phones are (703) 872-9318 for regular communications and (703) 872-9319 for After-Final communications.

CL

MATTHEW SMITH

SUPERVISORY PATENT EXAMINER TECHNOLOGY CENTER 2800

August 21, 2003